**2019 VLSI Symposia**

Press Registration Form

Please send this form to **VLSI Secretariat Japan and Asia** by e-mail <[vlsisymp@jtbcom.co.jp](mailto:vlsisymp@jtbcom.co.jp)>

**Privacy Policy**

Your personal information will be handled based on the Privacy Policy of 2019 VLSI Symposia.

Your application by filling out this form will be considered as you have agreed with our privacy policy.

**One form per participant. Please fill in block letters and check appropriate boxes.**

**<Participant>**

**Title** (Please check) Prof. Dr. Mr. Ms.

**Name**

**(Family Name) (Given Name) (Middle Initial)**

**Affiliation**

**Mailing Address** (Check) Office Home

Address      　　　Country

Tel: +      -      -      Fax: +      -      -

(Country code) (Area Code) (Country code) (Area Code)

Email      

**<Questionnaire >**

**MediaType** Journalist Photographer TV Radio Freelance Publicist Other(      )

**Distribution** Domestic International State Regional Other(      )

**Publication or broadcast schedule**      

**Where published or broadcasted? City**       **Country**     

**<Reporting activity >**

**Please check the category you are planning to report activity in**

|  |  |
| --- | --- |
| Category | |
| 1. Technology Short Course | 5. Symposia Luncheon Talk |
| 2. Technology Symposium | 6. Silicon Nanoelectronics Workshop |
| 3. Circuits Short Courses | 7. Demo & Reception |
| 4. Circuits Symposium | 8. Friday Forum |

**Will you attend the Joint Banquet (Free for PRESS) on June 7?**  Yes  No

**<Symposium Materials >**

**Please select symposium materials which you would like to have.**

**\*Press will be provided the following materials for free.**

**Please note if you would like additional materials, please purchase them on-site.**

|  |
| --- |
| Category |
| Technology Digest |
| Circuits Digest |

**<Cancellation>**

If you would like to cancel after you have turned in this form, please send an e-mail to the VLSI Secretariat Japan and Asia.

VLSI Secretariat Japan and Asia

Email: vlsisymp@jtbcom.co.jp

Tel: +81-3-5657-0777

**2019 VLSI Symposia: Privacy Policy**

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| **Policy on Handling of Personal Information** |

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| |  | | --- | | We, 2019 VLSI Symposia on VLSI Technology and Circuits (hereinafter the "Symposia"), are committed to protect the personal information of the applicants based on the Act on the Protection of Personal Information (personal information protection law in Japan), and shall handle the personal information collected through this registration form as mentioned below. The personal information that you submit through this form will be used in such cases as the following: - To operate and manage the Symposia - To contact you to carry forward your Symposia registration procedure - To provide the information of this Symposia and other related conferences - When we may need to contact you by some other reasons  For smooth operation of the Symposia, we are entrusting the operation of collecting, storing, managing and handling personal information regarding the Symposia to the following company, who will act as the Secretariat under a confidentiality agreement.  In case there is an error in your personal information collected for the Symposia, please inform the Secretariat to have it corrected or deleted. Offering personal information is voluntary, but please note without offering the necessary information, you are unable to attend the Symposia.  We do not use cookies and/or web beacons to acquire any personal information.  Contact Information of the Secretariat Managing the Personal Information JTB Communication Design, Inc. Attn: Yasuo Tsutsumi (General Manager) Celestine Shiba Mitsui Bldg. 3-23-1, Shiba, Minato-ku, Tokyo 105-8335, Japan Phone: +81-3-5657-0789 Email: vlsisymp@jtbcom.co.jp  Administrators of Personal Information Collected for the Secretariat Tadahiro Kuroda (Keio Univ.) Chair of JSAP Executive Committee | |